

INA121

FET-Input, Low Power INSTRUMENTATION AMPLIFIER

FEATURES

- LOW BIAS CURRENT: $\pm 4\text{pA}$
- LOW QUIESCENT CURRENT: $\pm 450\mu\text{A}$
- LOW INPUT OFFSET VOLTAGE: $\pm 200\mu\text{V}$
- LOW INPUT OFFSET DRIFT: $\pm 2\mu\text{V}/^\circ\text{C}$
- LOW INPUT NOISE:
 $20\text{nV}/\sqrt{\text{Hz}}$ at $f = 1\text{kHz}$ ($G = 100$)
- HIGH CMR: 106dB
- WIDE SUPPLY RANGE: $\pm 2.25\text{V}$ to $\pm 18\text{V}$
- LOW NONLINEARITY ERROR: 0.001% max
- INPUT PROTECTION TO $\pm 40\text{V}$
- 8-PIN DIP AND SO-8 SURFACE MOUNT

APPLICATIONS

- LOW-LEVEL TRANSDUCER AMPLIFIERS
Bridge, RTD, Thermocouple
- PHYSIOLOGICAL AMPLIFIERS
ECG, EEG, EMG, Respiratory
- HIGH IMPEDANCE TRANSDUCERS
- CAPACITIVE SENSORS
- MULTI-CHANNEL DATA ACQUISITION
- PORTABLE, BATTERY OPERATED SYSTEMS
- GENERAL PURPOSE INSTRUMENTATION

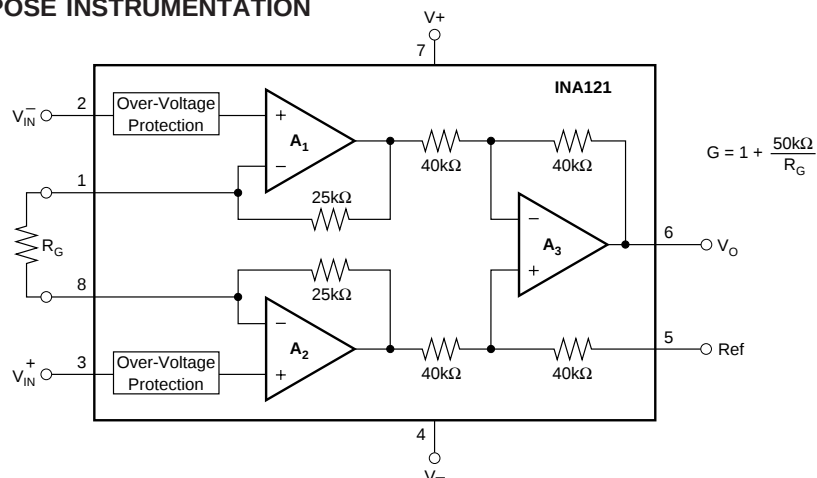
DESCRIPTION

The INA121 is a FET-input, low power instrumentation amplifier offering excellent accuracy. Its versatile three-op amp design and very small size make it ideal for a variety of general purpose applications. Low bias current ($\pm 4\text{pA}$) allows use with high impedance sources.

Gain can be set from 1V to 10,000V/V with a single external resistor. Internal input protection can withstand up to $\pm 40\text{V}$ without damage.

The INA121 is laser-trimmed for very low offset voltage ($\pm 200\mu\text{V}$), low offset drift ($\pm 2\mu\text{V}/^\circ\text{C}$), and high common-mode rejection (106dB at $G = 100$). It operates on power supplies as low as $\pm 2.25\text{V}$ ($+4.5\text{V}$), allowing use in battery operated and single 5V systems. Quiescent current is only $450\mu\text{A}$.

Package options include 8-pin plastic DIP and SO-8 surface mount. All are specified for the -40°C to $+85^\circ\text{C}$ industrial temperature range.



International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd., Tucson, AZ 85706 • Tel: (520) 746-1111 • Twx: 910-952-1111
Internet: <http://www.burr-brown.com/> • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

SPECIFICATIONS: $V_S = \pm 15V$

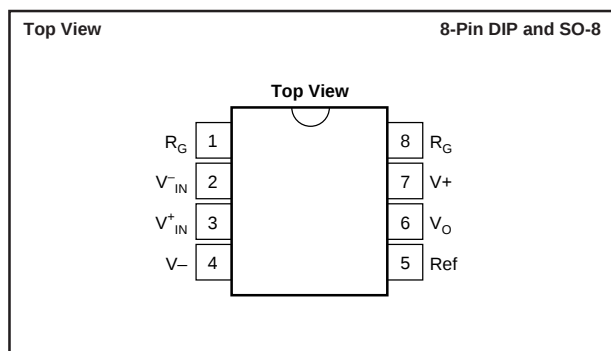
At $T_A = +25^\circ C$, $V_S = \pm 15V$, $R_L = 10k\Omega$, and I_A reference = 0V, unless otherwise noted.

PARAMETER	CONDITIONS	INA121P, U			INA121PA, UA			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
INPUT Offset Voltage, RTI vs Temperature vs Power Supply Long-Term Stability Impedance, Differential Common-Mode Input Voltage Range Safe Input Voltage Common-Mode Rejection	$V_S = \pm 2.25V$ to $\pm 18V$ $V_O = 0V$ $V_{CM} = -12.5V$ to $13.5V$ $G = 1$ $G = 10$ $G = 100$ $G = 1000$		$\pm 200 \pm 200/G$ $\pm 2 \pm 2/G$ $\pm 5 \pm 20/G$ ± 0.5 $10^{12} \parallel 1$ $10^{12} \parallel 12$ See Text and Typical Curves	$\pm 500 \pm 500/G$ $\pm 5 \pm 20/G$ $\pm 50 \pm 150/G$ ± 40		$\pm 300 \pm 200/G$ * * * * * *	$\pm 1000 \pm 1000/G$ $\pm 15 \pm 20/G$ * *	μV $\mu V/^\circ C$ $\mu V/V$ $\mu V/mo$ $\Omega \parallel pF$ $\Omega \parallel pF$ V dB dB dB dB
BIAS CURRENT vs Temperature Offset Current vs Temperature	$V_{CM} = 0V$		± 4 See Typical Curve ± 0.5 See Typical Curve	± 50		* * *	* 	pA pA
NOISE, RTI Voltage Noise: $f = 10Hz$ $f = 100Hz$ $f = 1kHz$ $f = 0.1Hz$ to $10Hz$ Current Noise: $f = 1kHz$	$R_S = 0\Omega$ $G = 100$ $G = 100$ $G = 100$ $G = 100$		30 21 20 1 1			* * * * *		$nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$ $\mu Vp-p$ $fA/\sqrt{Hz}$
GAIN Gain Equation Range of Gain Gain Error Gain vs Temperature ⁽¹⁾ Nonlinearity	$V_O = -14V$ to $13.5V$ $G = 1$ $G = 10$ $G = 100$ $G = 1000$ $G = 1$ $G > 1$ $V_O = -14V$ to $13.5V$ $G = 1$ $G = 10$ $G = 100$ $G = 1000$	1	$1 + (50k\Omega/R_G)$ ± 0.01 ± 0.03 ± 0.05 ± 0.5 ± 1 ± 25	10,000 ± 0.05 ± 0.4 ± 0.5 ± 10 ± 100	*	* * * * * *	* ± 0.1 ± 0.5 ± 0.7 * *	V/V V/V % % % % ppm/ $^\circ C$ ppm/ $^\circ C$ % of FSR % of FSR % of FSR % of FSR
OUTPUT Voltage: Positive Negative Positive Negative Capacitance Load Drive Short-Circuit Current	$R_L = 100k\Omega$ $R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 10k\Omega$	$(V_+) - 1.5$ $(V_-) + 1$	$(V_+) - 0.9$ $(V_-) + 0.15$ $(V_+) - 0.9$ $(V_-) + 0.25$ 1000 ± 14		*	* * * * * *		V V V V pF mA
FREQUENCY RESPONSE Bandwidth, -3dB Slew Rate Settling Time, 0.01% Overload Recovery	$G = 1$ $G = 10$ $G = 100$ $G = 1000$ $V_O = \pm 10V$, $G \leq 10$ $G = 1$ to 10 $G = 100$ $G = 1000$ 50% Input Overload		600 300 50 5 0.7 20 35 260 5			* * * * * * * * *		kHz kHz kHz kHz V/ μs μs μs μs μs
POWER SUPPLY Voltage Range Quiescent Current	$I_O = 0V$	± 2.25	± 15 ± 450	± 18 ± 525	*	* *	* *	V μA
TEMPERATURE RANGE Specification Operating Storage Thermal Resistance, θ_{JA} 8-Lead DIP SO-8 Surface Mount		-40 -55 -55		85 125 125	* * *		* * *	$^\circ C$ $^\circ C$ $^\circ C$ $^\circ C/W$ $^\circ C/W$

* Specification same as INA121P, U.

NOTE: (1) Temperature coefficient of the "Internal Resistor" in the gain equation. Does not include TCR of gain-setting resistor, R_G .

PIN CONFIGURATION



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply Voltage	±18V
Analog Input Voltage Range	±40V
Output Short-Circuit (to ground)	Continuous
Operating Temperature	–55°C to +125°C
Storage Temperature	–55°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	+300°C

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

PACKAGE/ORDERING INFORMATION

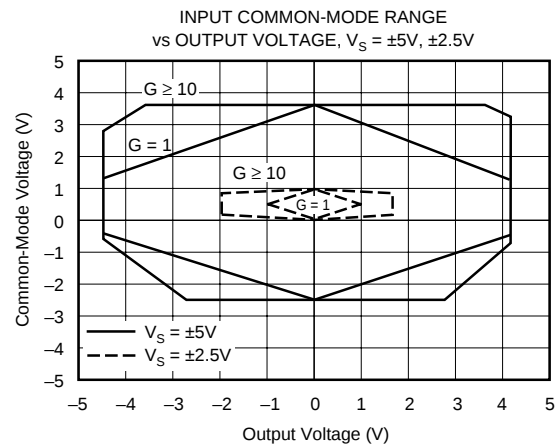
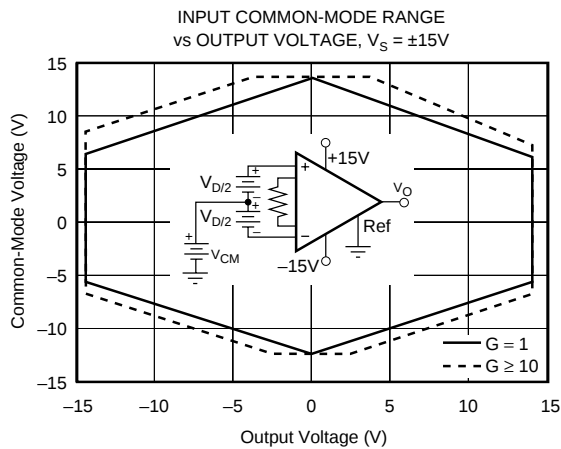
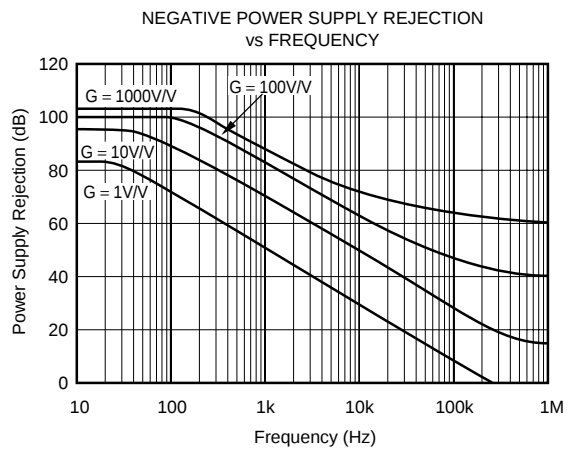
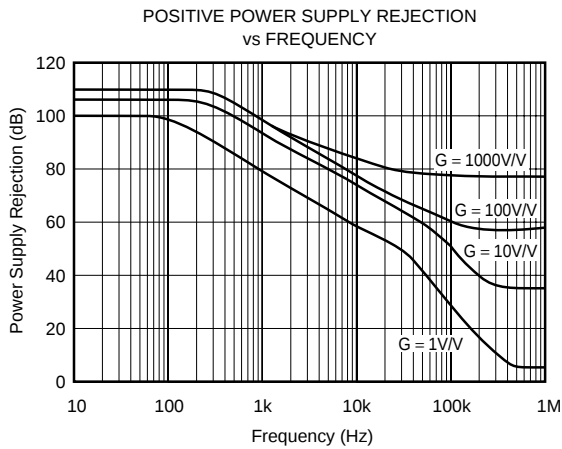
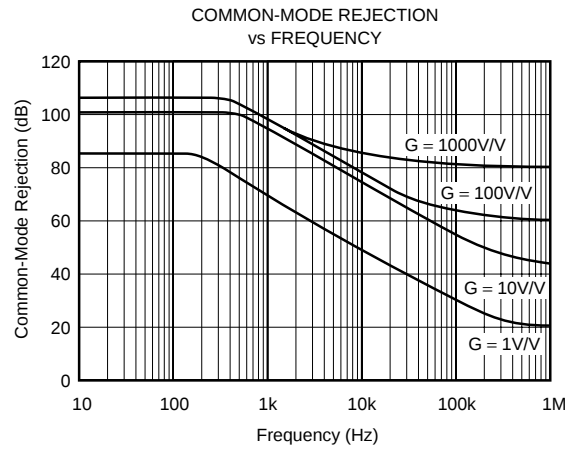
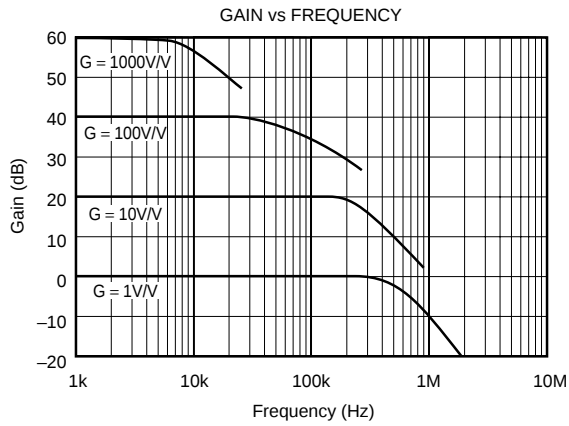
PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽²⁾	TRANSPORT MEDIA
Single						
INA121P	8-Pin DIP	006	–40°C to +85°C	INA121P	INA121P	Rails
INA121PA	8-Pin DIP	006	–40°C to +85°C	INA121PA	INA121PA	Rails
INA121U	SO-8 Surface-Mount	182	–40°C to +85°C	INA121U	INA121U	Rails
"	"	"	"	"	INA121U/2K5	Tape and Reel
INA121UA	SO-8 Surface-Mount	182	–40°C to +85°C	INA121UA	INA121UA	Rails
"	"	"	"	"	INA121UA/2K5	Tape and Reel

NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "INA121U/2K5" will get a single 2500-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.

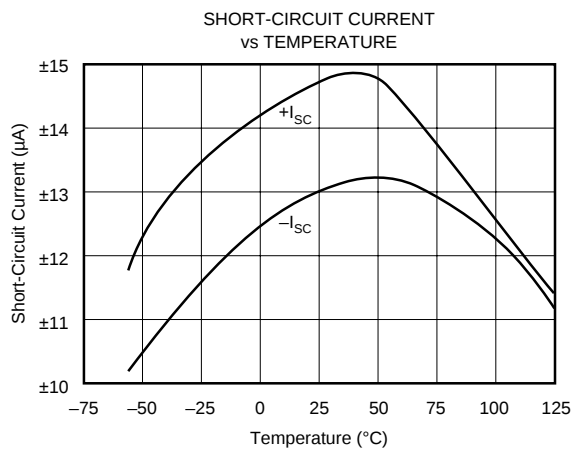
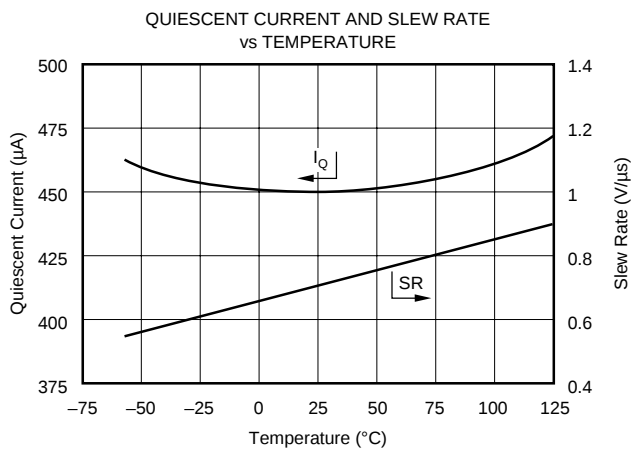
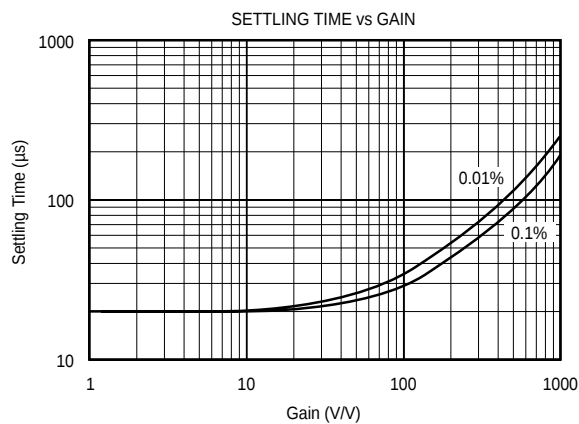
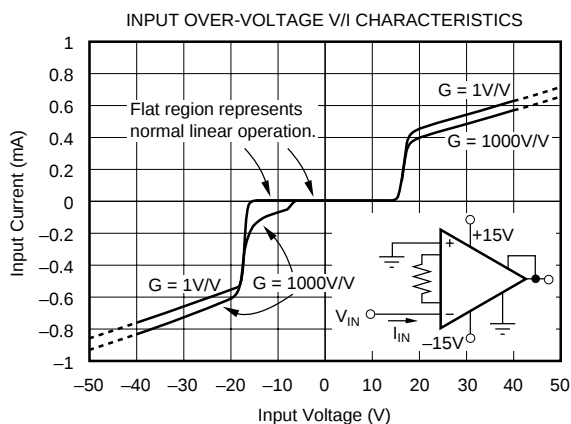
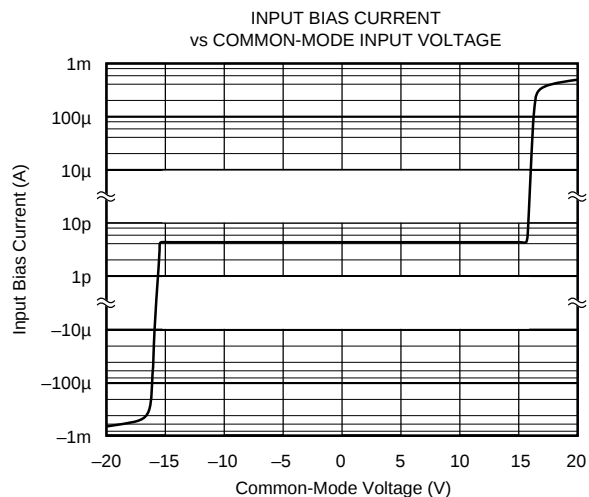
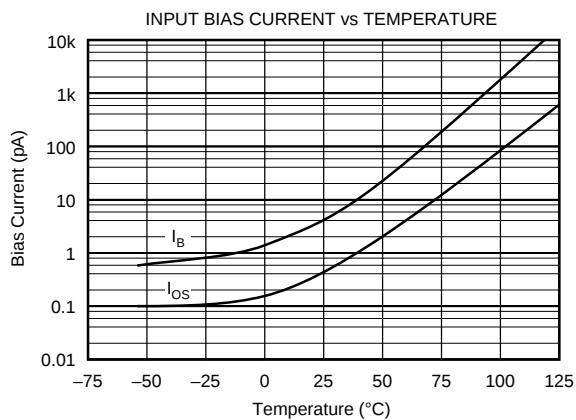
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



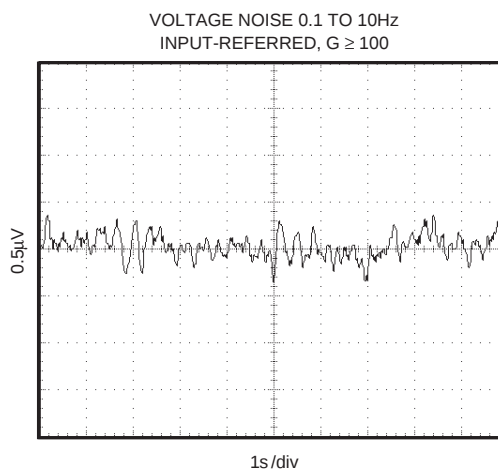
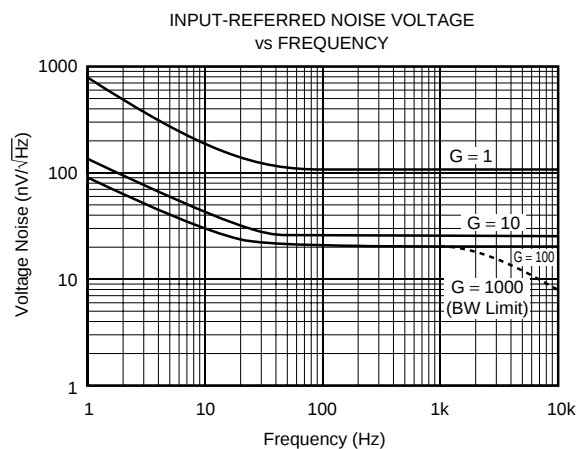
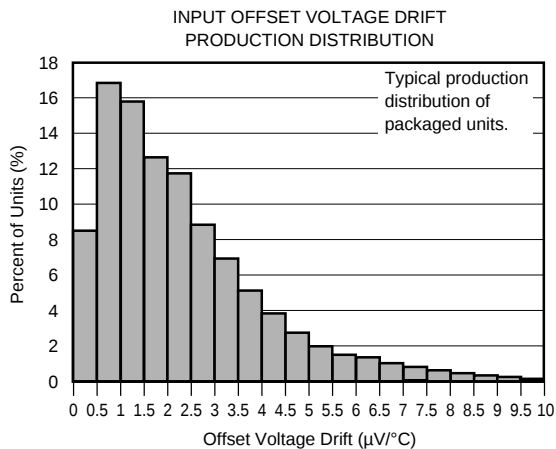
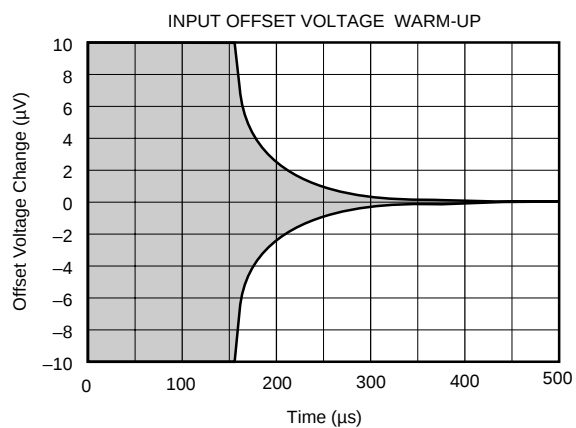
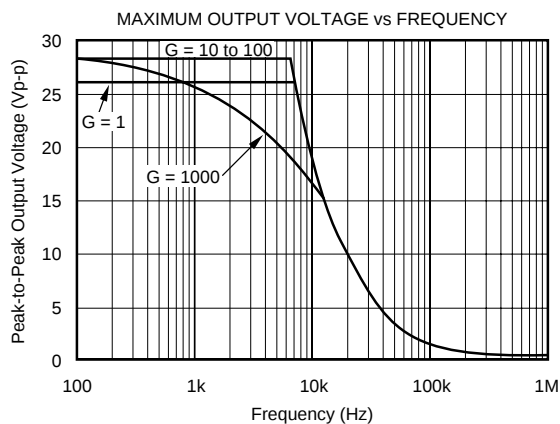
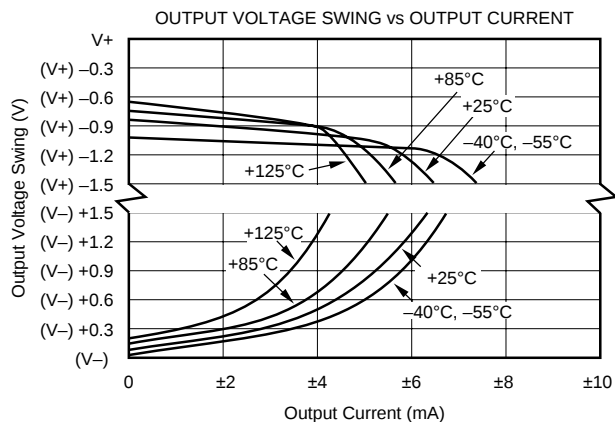
TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



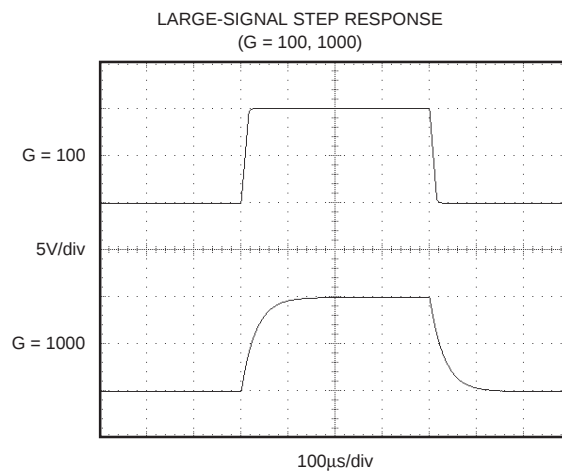
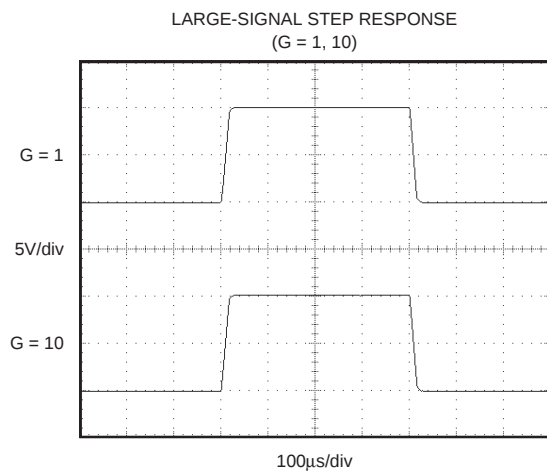
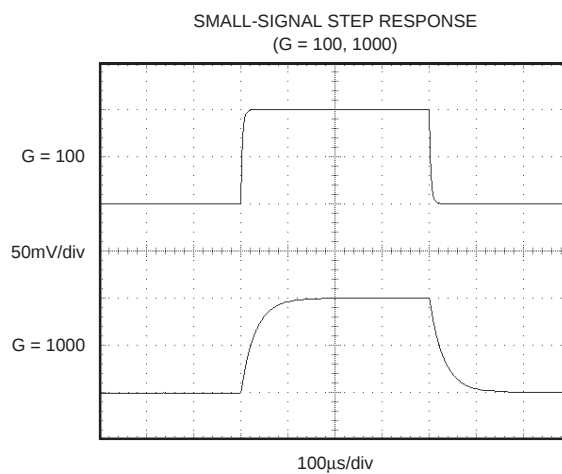
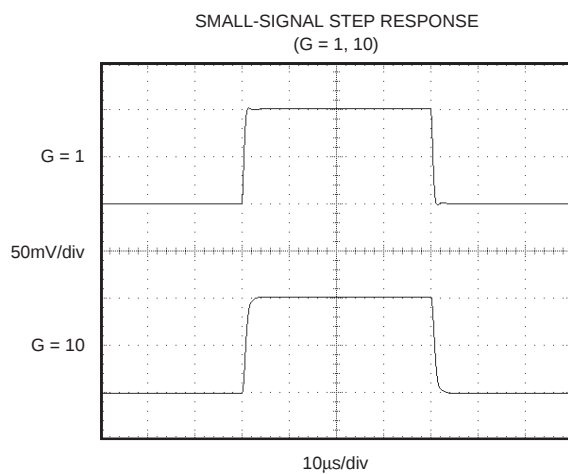
TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the INA121. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

The output is referred to the output reference (Ref) terminal which is normally grounded. This must be a low-impedance connection to assure good common-mode rejection. A resistance of 8Ω in series with the Ref pin will cause a typical device to degrade to approximately 80dB CMR ($G = 1$).

SETTING THE GAIN

Gain of the INA121 is set by connecting a single external resistor, R_G , connected between pins 1 and 8:

$$G = 1 + \frac{50k\Omega}{R_G} \quad (1)$$

Commonly used gains and resistor values are shown in Figure 1.

The 50kΩ term in Equation 1 comes from the sum of the two internal feedback resistors of A_1 and A_2 . These on-chip metal film resistors are laser trimmed to accurate absolute values. The accuracy and temperature coefficient of these resistors are included in the gain accuracy and drift specifications of the INA121.

The stability and temperature drift of the external gain setting resistor, R_G , also affects gain. R_G 's contribution to gain accuracy and drift can be directly inferred from the gain equation (1). Low resistor values required for high gain can make wiring resistance important. Sockets add to the wiring resistance which will contribute additional gain error (possibly an unstable gain error) in gains of approximately 100 or greater.

DYNAMIC PERFORMANCE

The typical performance curve "Gain vs Frequency" shows that, despite its low quiescent current, the INA121 achieves wide bandwidth, even at high gain. This is due to the current-feedback topology of the INA121. Settling time also remains excellent at high gain.

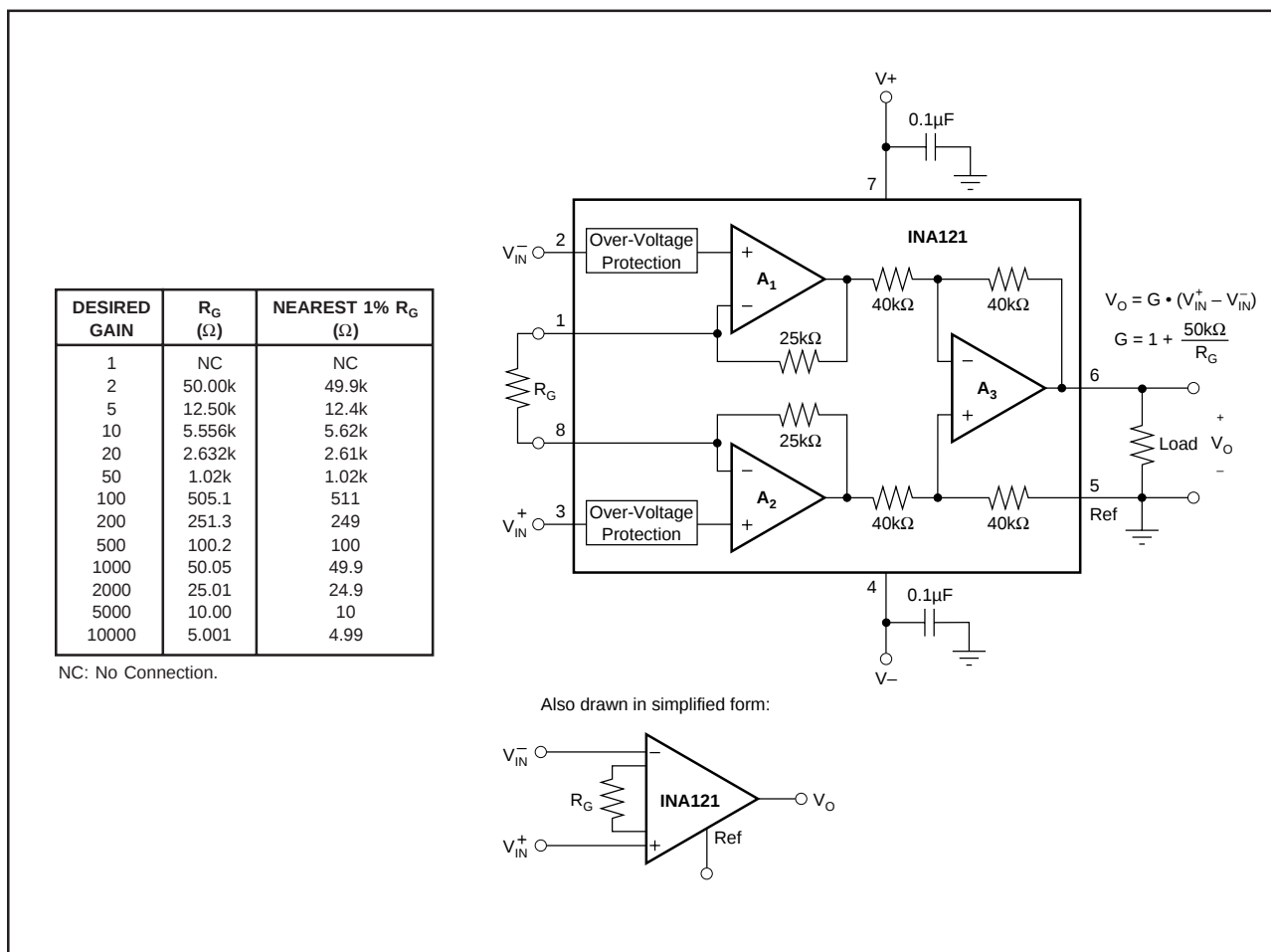


FIGURE 1. Basic Connections.

The INA121 provides excellent rejection of high frequency common-mode signals. The typical performance curve, “Common-Mode Rejection vs Frequency” shows this behavior. If the inputs are not properly balanced, however, common-mode signals can be converted to differential signals. Run the V_{IN}^+ and V_{IN}^- connections directly adjacent each other, from the source signal all the way to the input pins. If possible use a ground plane under both input traces. Avoid running other potentially noisy lines near the inputs.

NOISE AND ACCURACY PERFORMANCE

The INA121’s FET input circuitry provides low input bias current and high speed. It achieves lower noise and higher accuracy with high impedance sources. With source impedances of 2k Ω to 50k Ω the INA114, INA128, or INA129 may provide lower offset voltage and drift. For very low source impedance ($\leq 1\text{k}\Omega$), the INA103 may provide improved accuracy and lower noise. At very high source impedances ($> 1\text{M}\Omega$) the INA116 is recommended.

OFFSET TRIMMING

The INA121 is laser trimmed for low offset voltage and drift. Most applications require no external offset adjustment. Figure 2 shows an optional circuit for trimming the output offset voltage. The voltage applied to Ref terminal is summed at the output. The op amp buffer provides low impedance at the Ref terminal to preserve good common-mode rejection. Trim circuits with higher source impedance should be buffered with an op amp follower circuit to assure low impedance on the Ref pin.

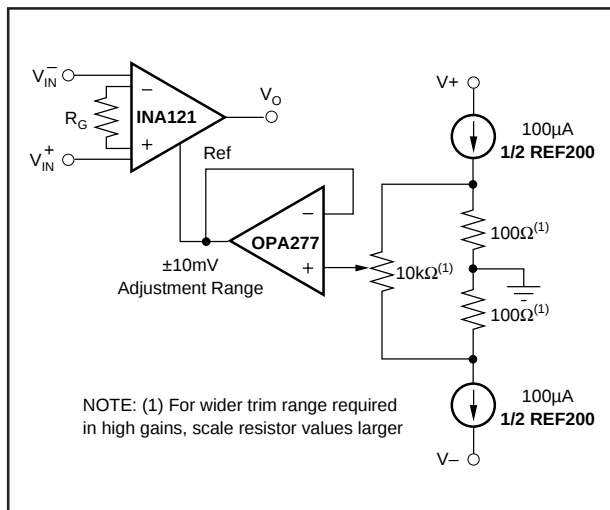


FIGURE 2. Optional Trimming of Output Offset Voltage.

INPUT BIAS CURRENT RETURN PATH

The input impedance of the INA121 is extremely high—approximately $10^{12}\Omega$. However, a path must be provided for the input bias current of both inputs. This input bias current is typically 4pA. High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current if the INA121 is to operate properly. Figure 3 shows various provisions for an input bias current path. Without a bias current return path, the inputs will float to a potential which exceeds the common-mode range of the INA121 and the input amplifiers will saturate.

If the differential source resistance is low, the bias current return path can be connected to one input (see the thermocouple example in Figure 3). With higher source impedance, using two resistors provides a balanced input with possible advantages of lower input offset voltage due to bias current and better high-frequency common-mode rejection.

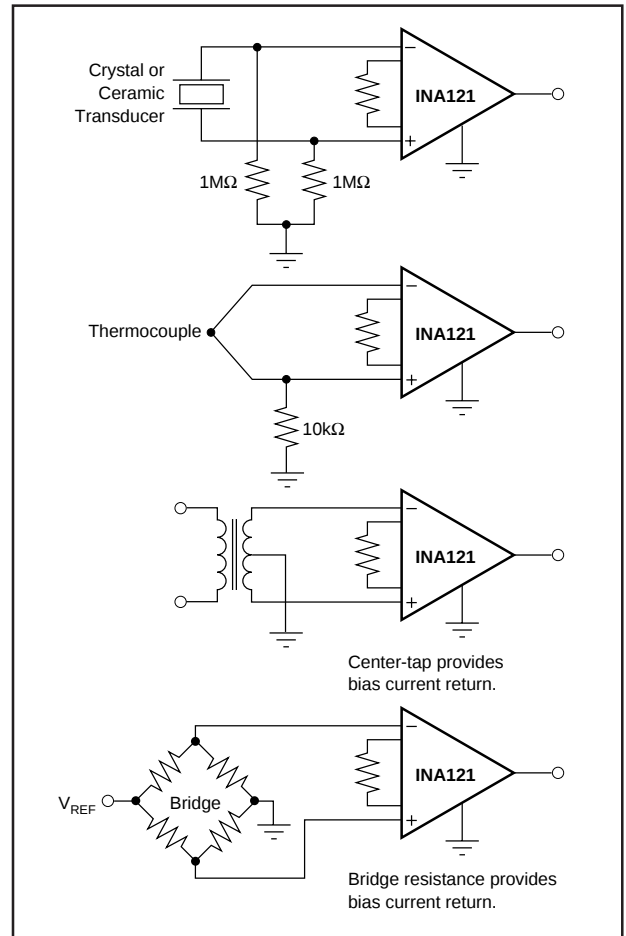


FIGURE 3. Providing an Input Common-Mode Current Path.

INPUT COMMON-MODE RANGE

The linear input voltage range of the input circuitry of the INA121 is from approximately 1.2V below the positive supply voltage to 2.1V above the negative supply. A differential input voltage causes the output voltage to increase. The linear input range, however, will be limited by the output voltage swing of amplifiers A_1 and A_2 . So the linear common-mode input range is related to the output voltage of the complete amplifier. This behavior also depends on supply voltage—see typical performance curve “Input Common-Mode Range vs Output Voltage”.

A combination of common-mode and differential input voltage can cause the output of A_1 or A_2 to saturate. Figure 4 shows the output voltage swing of A_1 and A_2 expressed in terms of a common-mode and differential input voltages. For applications where input common-mode range must be maximized, limit the output voltage swing by connecting the INA121 in a lower gain (see performance curve “Input Common-Mode Voltage Range vs Output Voltage”). If necessary, add gain after the INA121 to increase the voltage swing.

Input-overload can produce an output voltage that appears normal. For example, if an input overload condition drives both input amplifiers to their positive output swing limit, the difference voltage measured by the output amplifier will be near zero. The output of A_3 will be near 0V even though both inputs are overloaded.

LOW VOLTAGE OPERATION

The INA121 can be operated on power supplies as low as $\pm 2.25V$. Performance remains excellent with power supplies ranging from $\pm 2.25V$ to $\pm 18V$. Most parameters vary only slightly throughout this supply voltage range—see typical

performance curves. Operation at very low supply voltage requires careful attention to assure that the input voltages remain within their linear range. Voltage swing requirements of internal nodes limit the input common-mode range with low power supply voltage. Typical performance curves, “Input Common-Mode Range vs Output Voltage” show the range of linear operation for $\pm 15V$, $\pm 5V$, and $\pm 2.5V$ supplies.

INPUT FILTERING

The INA121’s FET input allows use of an R/C input filter without creating large offsets due to input bias current. Figure 5 shows proper implementation of this input filter to preserve the INA121’s excellent high frequency common-mode rejection. Mismatch of the common-mode input time constant (R_1C_1 and R_2C_2), either from stray capacitance or mismatched values, causes a high frequency common-mode signal to be converted to a differential signal. This degrades common-mode rejection. The differential input capacitor, C_3 , reduces the bandwidth and mitigates the effects of mismatch in C_1 and C_2 . Make C_3 much larger than C_1 and C_2 . If properly matched, C_1 and C_2 also improve ac CMR.

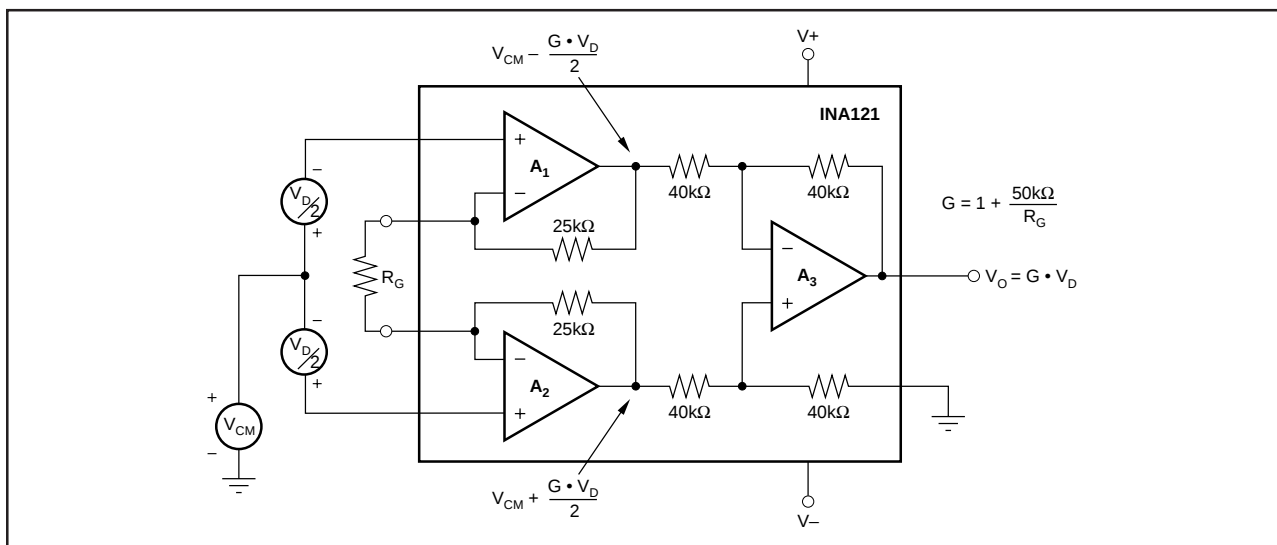


FIGURE 4. Voltage Swing of A_1 and A_2 .

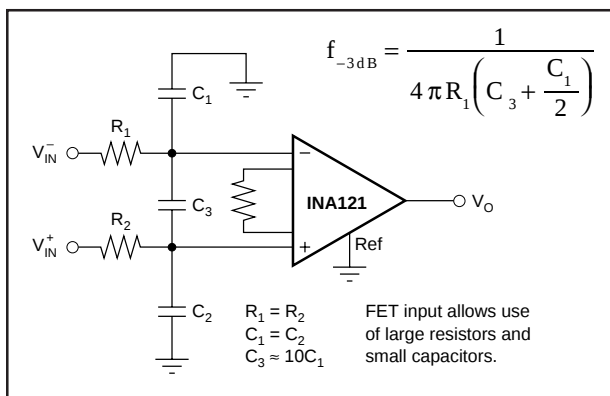


FIGURE 5. Input Low-Pass Filter.

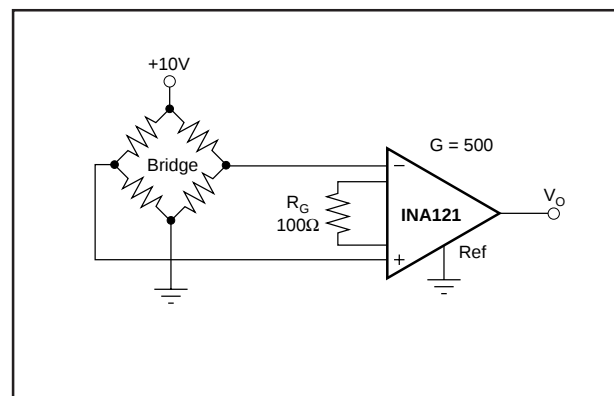


FIGURE 6. Bridge Transducer Amplifier.

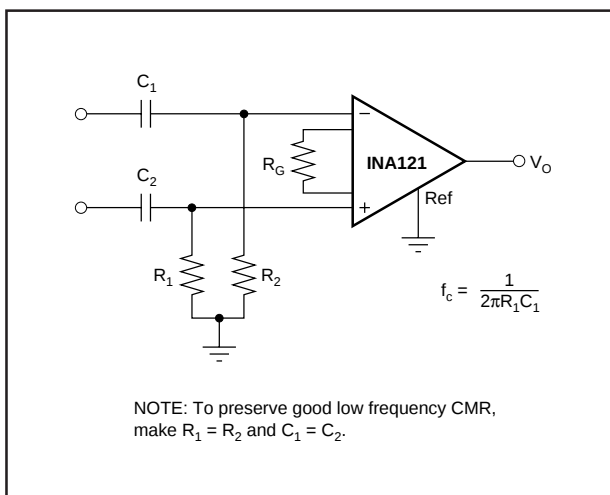


FIGURE 7. High-Pass Input Filter.

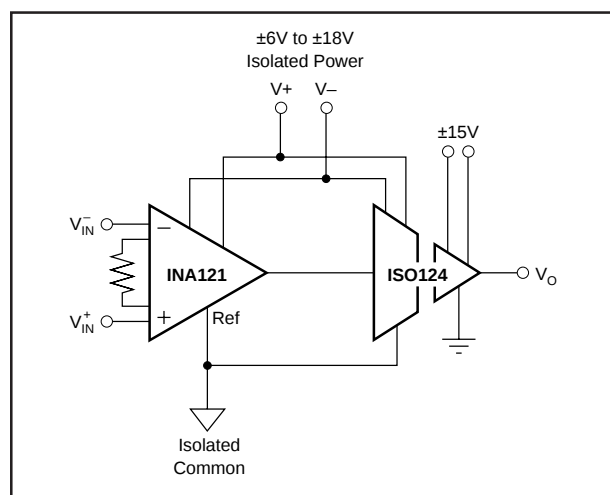


FIGURE 8. Galvanically Isolated Instrumentation Amplifier.

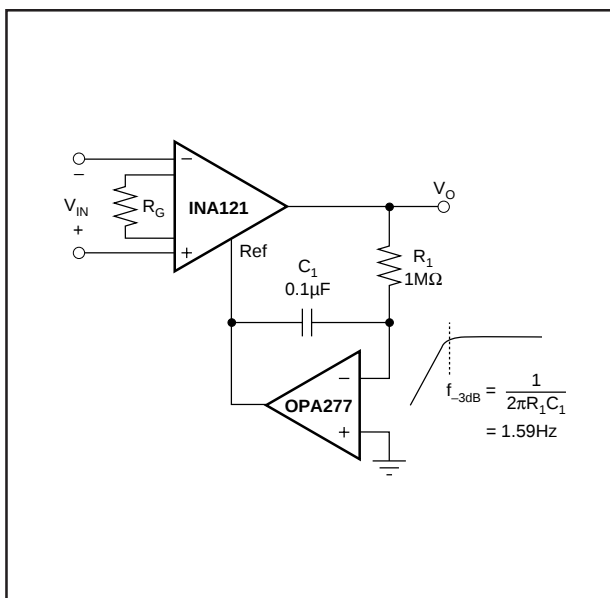


FIGURE 9. AC-Coupled Instrumentation Amplifier.

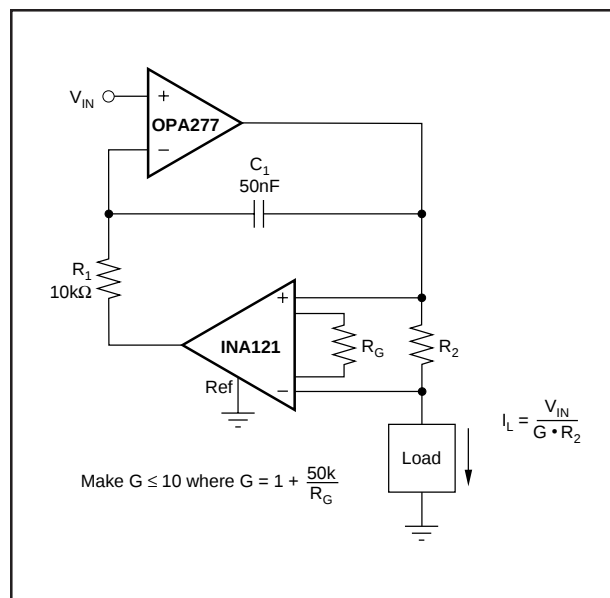


FIGURE 10. Voltage Controlled Current Source.

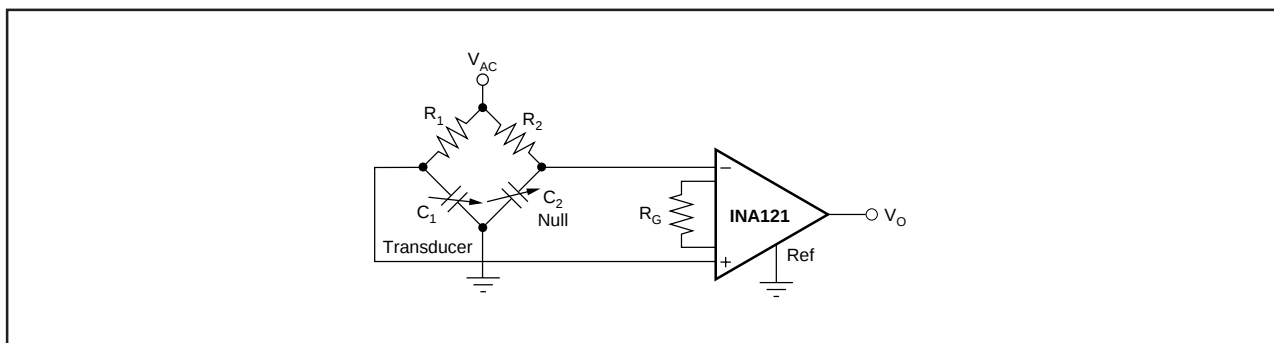


FIGURE 11. Capacitive Bridge Transducer Circuit.

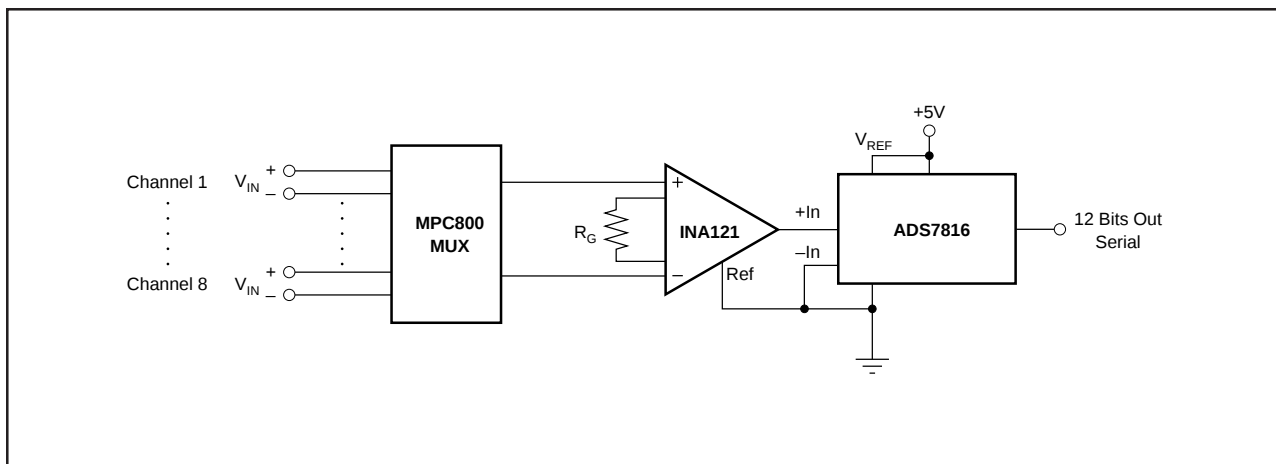


FIGURE 12. Multiplexed-Input Data Acquisition System.

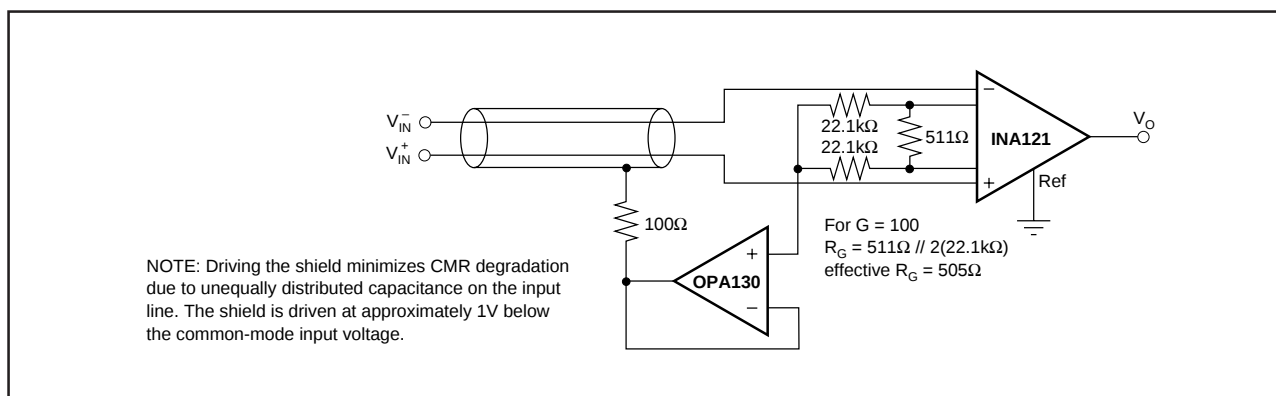


FIGURE 13. Shield Driver Circuit.

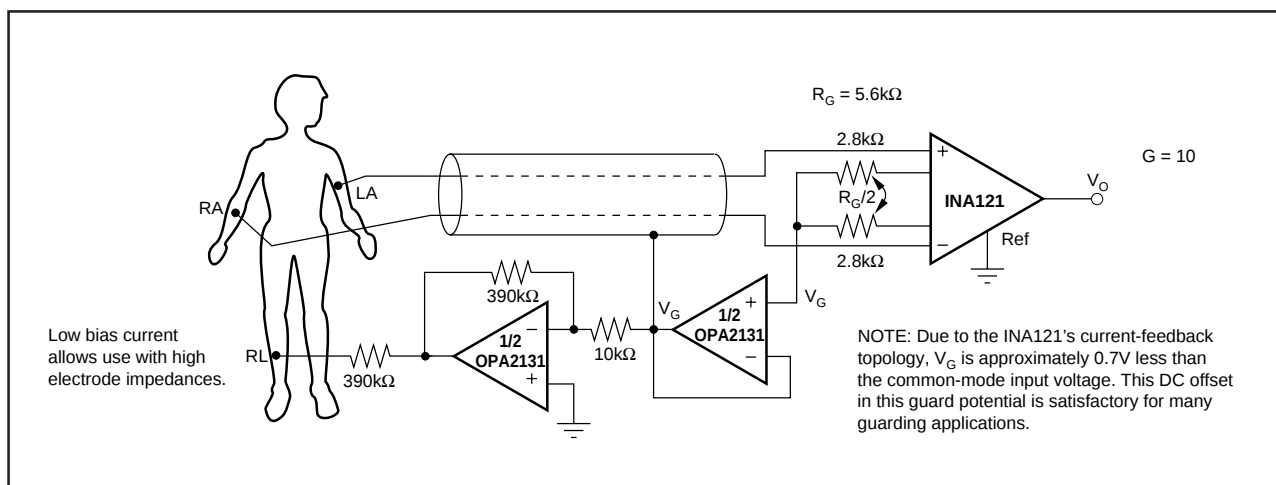


FIGURE 14. ECG Amplifier With Right-Leg Drive.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
INA121P	Active	Production	PDIP (P) 8	50 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	INA121P A
INA121P.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	INA121P A
INA121PA	Active	Production	PDIP (P) 8	50 TUBE	Yes	Call TI	N/A for Pkg Type	-	INA121P A
INA121PA.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	INA121P A
INA121U	Active	Production	SOIC (D) 8	75 TUBE	Yes	Call TI	Level-3-260C-168 HR	-	INA 121U
INA121U.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	INA 121U
INA121U/2K5	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-	INA 121U
INA121U/2K5.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	INA 121U
INA121UA	Active	Production	SOIC (D) 8	75 TUBE	Yes	Call TI	Level-3-260C-168 HR	-	INA 121U A
INA121UA.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	INA 121U A
INA121UA/2K5	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-	INA 121U A
INA121UA/2K5.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	INA 121U A

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

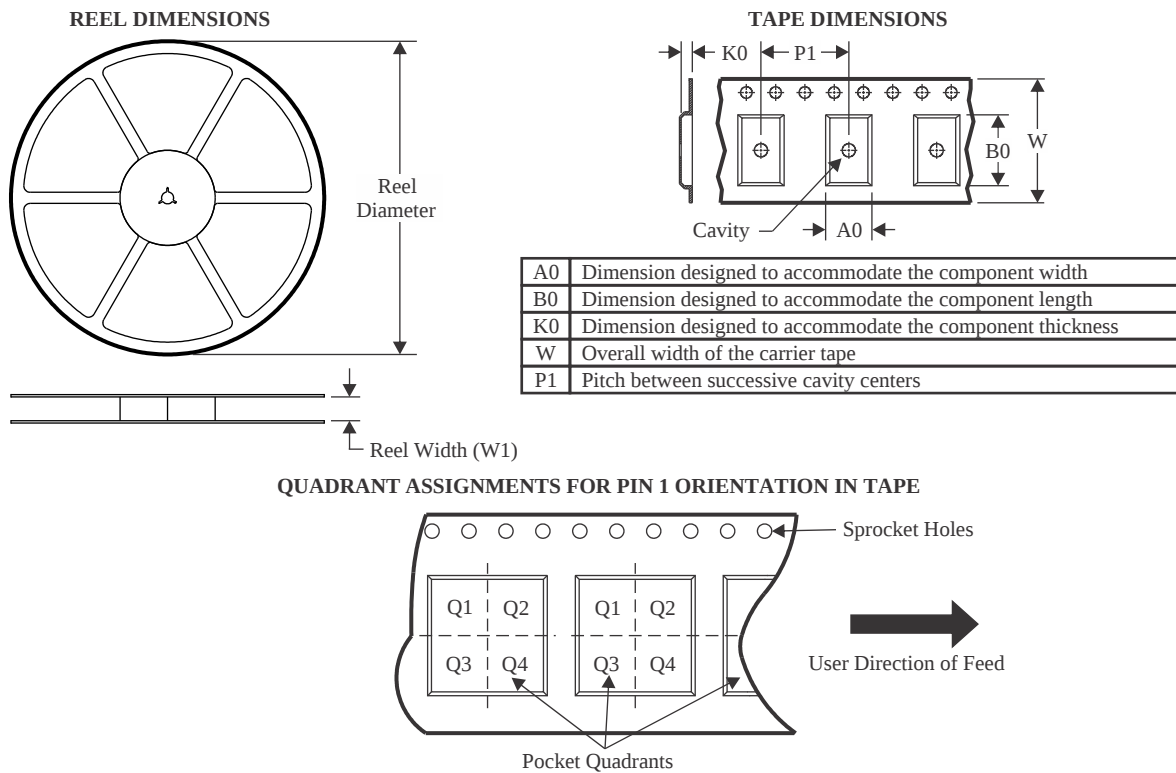
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA121U/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA121UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



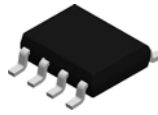
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA121U/2K5	SOIC	D	8	2500	367.0	367.0	35.0
INA121UA/2K5	SOIC	D	8	2500	356.0	356.0	35.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
INA121P	P	PDIP	8	50	506	13.97	11230	4.32
INA121P.A	P	PDIP	8	50	506	13.97	11230	4.32
INA121PA	P	PDIP	8	50	506	13.97	11230	4.32
INA121PA.A	P	PDIP	8	50	506	13.97	11230	4.32
INA121U	D	SOIC	8	75	506.6	8	3940	4.32
INA121U.A	D	SOIC	8	75	506.6	8	3940	4.32
INA121UA	D	SOIC	8	75	506.6	8	3940	4.32
INA121UA.A	D	SOIC	8	75	506.6	8	3940	4.32

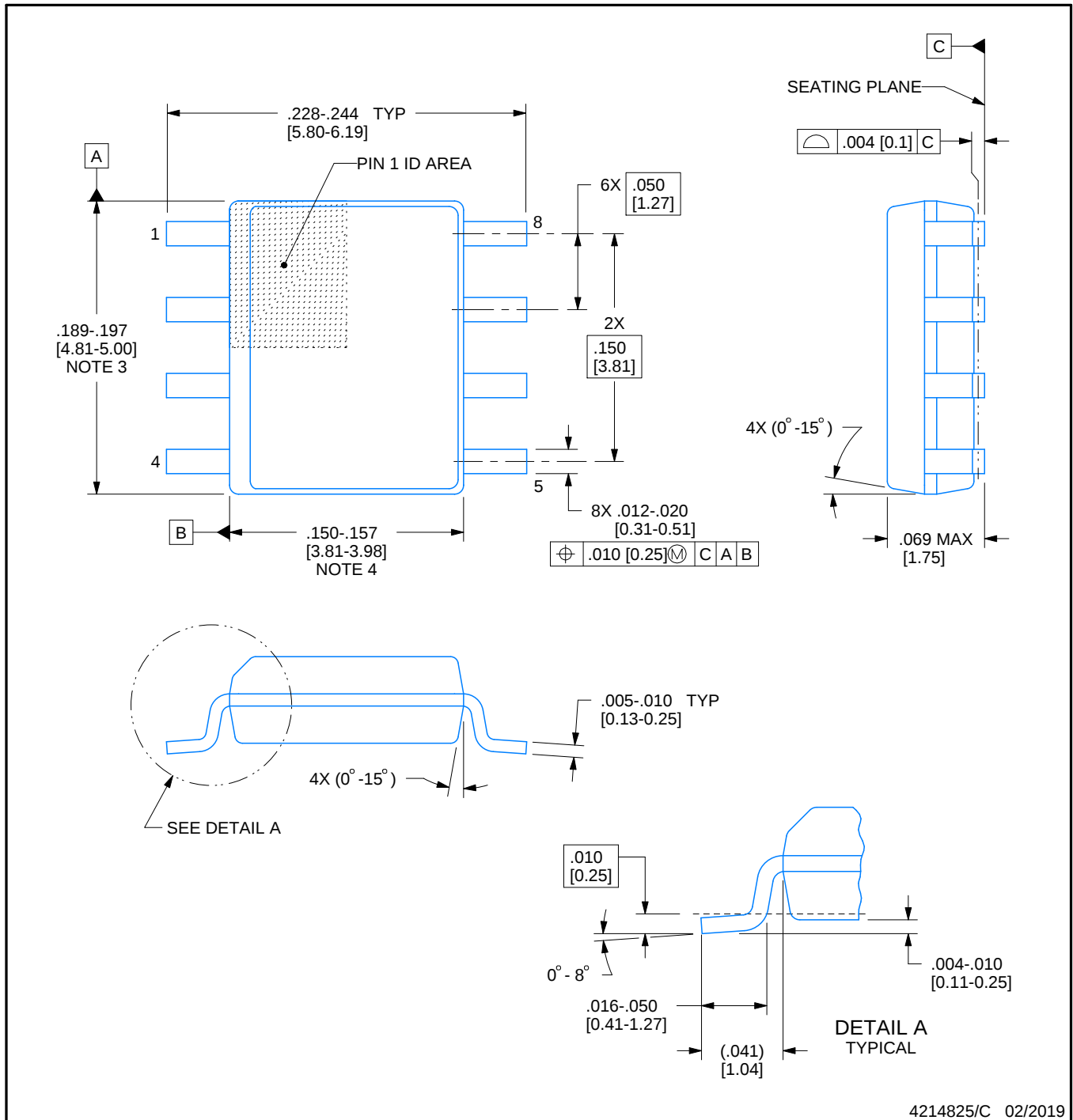


D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



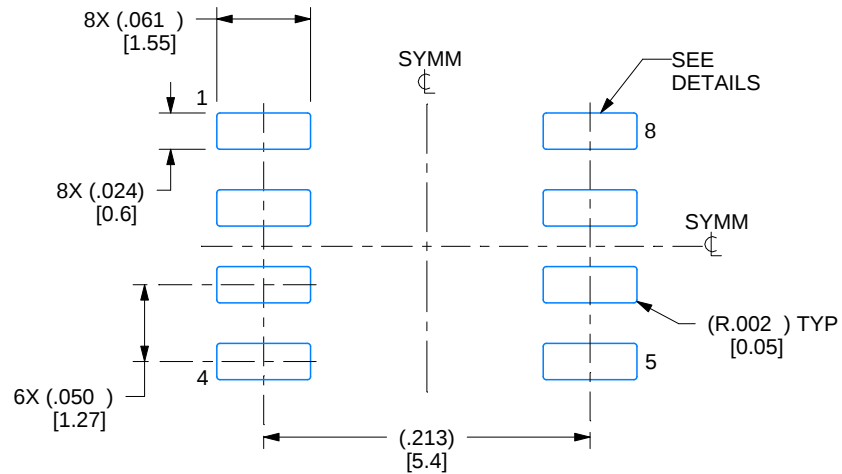
NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

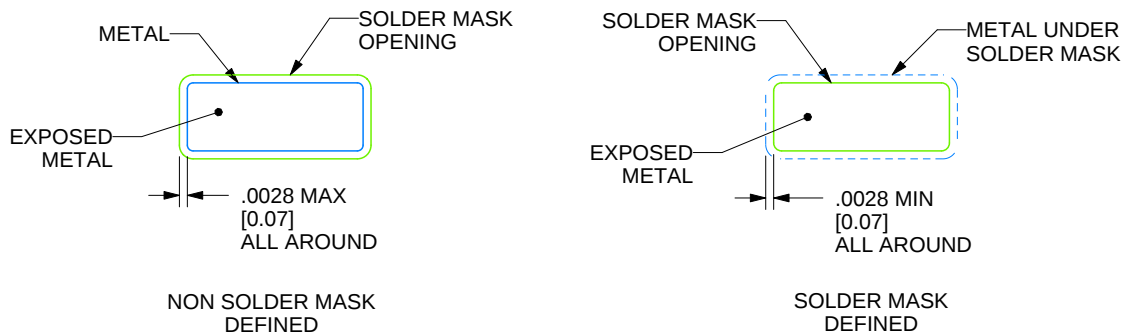
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

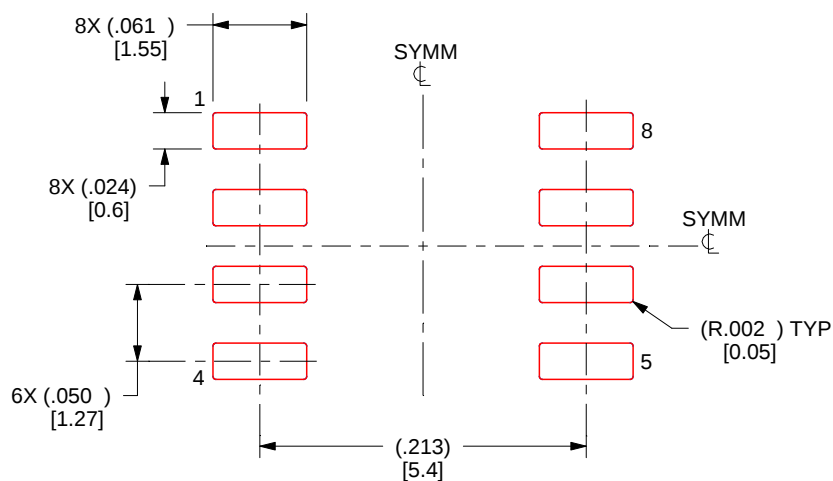
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2025, Texas Instruments Incorporated